HSK 2014	Product Description	Base Rate	Year 1	Year 2	Year 3	Year 4	Year 5	Year 6	Year 7	Year 8	Year 9	Year 10	Year 11	Year 12	Year 13	Year 14	Year 15	Year 16	Year 17	Year 18	Year 19	Year 20 and Subsequent Years
7406.20.20.00	Flakes	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7407	**Copper bars, rods and profiles.**																					
7407.10.00.00	Of refined copper	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7407.2	Of copper alloys:																					
7407.21.00.00	Of copper-zinc base alloys (brass)	8.0%	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U
7407.29	**Other**																					
7407.29.10.00	Of copper-tin base alloys (bronze)	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7407.29.20	Of copper-nickel base alloys (cupro-nickel) or copper-nickel-zinc base alloys (nickel silver)																					
7407.29.20.10	Of copper-nickel base alloys (cupro-nickel)	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7407.29.20.20	Of copper-nickel-zinc base alloys (nickel silver)	8.0%	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U
7407.29.90.00	Other	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7408	**Copper wire.**																					
7408.1	Of refined copper:																					
7408.11.00.00	Of which the maximum cross-sectional dimension exceeds 6 ㎜	8.0%	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U
7408.19.00.00	Other	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7408.2	Of copper alloys:																					
7408.21.00.00	Of copper-zinc base alloys (brass)	8.0%	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U
7408.22	**Of copper-nickel base alloys (cupro-nickel) or copper-nickel-zinc base alloys (nickel silver)**																					
7408.22.10.00	Of copper-nickel base alloys (cupro-nickel)	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7408.22.20.00	Of copper-nickel-zinc base alloys (nickel silver)	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7408.29	**Other**																					
7408.29.10.00	Of copper-tin base alloys (bronze)	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7408.29.90.00	Other	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7409	**Copper plates, sheets and strip, of a thickness exceeding 0.15 ㎜.**																					
7409.1	Of refined copper:																					
7409.11	**In coils**																					
7409.11.10.00	For use in manufacturing semiconductor	5.0%	4.7%	4.3%	4.0%	3.7%	3.3%	3.0%	2.7%	2.3%	2.0%	1.7%	1.3%	1.0%	0.7%	0.3%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7409.11.90.00	Other	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7409.19	**Other**																					
7409.19.10.00	For use in manufacturing semiconductor	5.0%	4.7%	4.3%	4.0%	3.7%	3.3%	3.0%	2.7%	2.3%	2.0%	1.7%	1.3%	1.0%	0.7%	0.3%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7409.19.90.00	Other	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7409.2	Of copper-zinc base alloys (brass):																					
7409.21	**In coils**																					
7409.21.10.00	For use in manufacturing semiconductor	5.0%	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U
7409.21.90.00	Other	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7409.29	**Other**																					
7409.29.10.00	For use in manufacturing semiconductor	5.0%	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U

HSK 2014	Product Description	Base Rate	Year 1	Year 2	Year 3	Year 4	Year 5	Year 6	Year 7	Year 8	Year 9	Year 10	Year 11	Year 12	Year 13	Year 14	Year 15	Year 16	Year 17	Year 18	Year 19	Year 20 and Subsequent Years
7409.29.90.00	Other	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7409.3	Of copper-tin base alloys (bronze):																					
7409.31	**In coils**																					
7409.31.10.00	For use in manufacturing semiconductor	5.0%	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U
7409.31.90.00	Other	8.0%	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U
7409.39	**Other**																					
7409.39.10.00	For use in manufacturing semiconductor	5.0%	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U
7409.39.90.00	Other	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7409.40	**Of copper-nickel base alloys (cupro-nickel) or copper-nickel-zinc base alloys (nickel silver)**																					
7409.40.10	Of copper-nickel base alloys (cupro-nickel)																					
7409.40.10.10	For use in manufacturing semiconductor	5.0%	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U
7409.40.10.90	Other	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7409.40.20	Of copper-nickel-zinc base alloys (nickel silver)																					
7409.40.20.10	For use in manufacturing semiconductor	5.0%	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U
7409.40.20.90	Other	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7409.90	**Of other copper alloys**																					
7409.90.10.00	For use in manufacturing semiconductor	5.0%	4.7%	4.3%	4.0%	3.7%	3.3%	3.0%	2.7%	2.3%	2.0%	1.7%	1.3%	1.0%	0.7%	0.3%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7409.90.90.00	Other	8.0%	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U
7410	**Copper foil (whether or not printed or backed with paper, paperboard, plastics or similar backing materials) of a thickness (excluding any backing) not exceeding 0.15 ㎜.**																					
7410.1	Not backed:																					
7410.11.00.00	Of refined copper	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7410.12.00.00	Of copper alloys	8.0%	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U
7410.2	Backed:																					
7410.21	**Of refined copper**																					
7410.21.10.00	Suitable for manufacturing printed circuit board	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7410.21.90.00	Other	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7410.22	**Of copper alloys**																					
7410.22.10.00	Suitable for manufacturing printed circuit board	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7410.22.90.00	Other	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7411	**Copper tubes and pipes.**																					
7411.10.00.00	Of refined copper	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7411.2	Of copper alloys:																					
7411.21.00.00	Of copper-zinc base alloys (brass)	8.0%	7.5%	6.9%	6.4%	5.9%	5.3%	4.8%	4.3%	3.7%	3.2%	2.7%	2.1%	1.6%	1.1%	0.5%	0.0%	0.0%	0.0%	0.0%	0.0%	0.0%
7411.22	**Of copper-nickel base alloys (cupro-nickel) or copper-nickel-zinc base alloys (nickel silver)**																					